

#### Maximum Ratings @T<sub>A</sub> = 25°C unless otherwise specified

Characteristic	Symbol	Value	Unit	Conditions
Peak Pulse Power Dissipation	P <sub>PP</sub>	130	W	8/20μs, Per Fig. 1
Peak Pulse Current	IPP	12	А	8/20μs, Per Fig. 1
ESD Protection – Contact Discharge	V <sub>ESD_Contact</sub>	±30	kV	IEC 61000-4-2 Standard
ESD Protection – Air Discharge	$V_{ESD_{Air}}$	±30	kV	IEC 61000-4-2 Standard

#### **Thermal Characteristics**

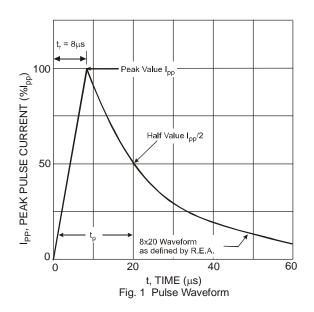
Characteristic	Symbol	Value	Unit
Package Power Dissipation (Note 5)	PD	250	mW
Thermal Resistance, Junction to Ambient (Note 5)	R <sub>0</sub> JA	500	°C/W
Operating and Storage Temperature Range	T <sub>J</sub> , T <sub>STG</sub>	-65 to +150	٥C

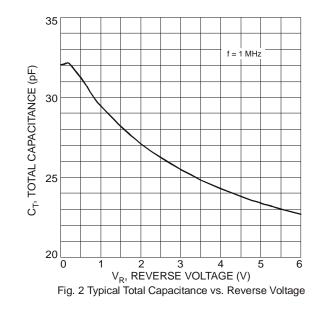
### Electrical Characteristics @T<sub>A</sub> = 25°C unless otherwise specified

Characteristic	Symbol	Min	Тур	Max	Unit	Test Conditions
Reverse Standoff Voltage	V <sub>RWM</sub>	-	-	5	V	-
Channel Leakage Current (Note 6)	I <sub>RM</sub>	-	5	100	nA	$V_{RWM} = 5V$
Clamping Voltage	V <sub>CL</sub>	-	-	10 14	V	$I_{PP} = 1A, t_p = 8/20\mu S$ $I_{PP} = 12A, t_p = 8/20\mu S$
Breakdown Voltage	V <sub>BR</sub>	5.5	-	9.5	V	I <sub>R</sub> = 1mA
Differential Resistance	R <sub>DIF</sub>	-	0.4	-	Ω	$I_R = 10A, t_p = 8/20\mu S$
Channel Input Capacitance	CT	-	35	45	pF	$V_R = 0V, f = 1MHz$

Notes: 5. Device mounted on FR-4 PCB pad layout (2oz copper) as shown on Diodes, Inc. suggested pad layout AP02001, which can be found on our website at http://www.diodes.com.

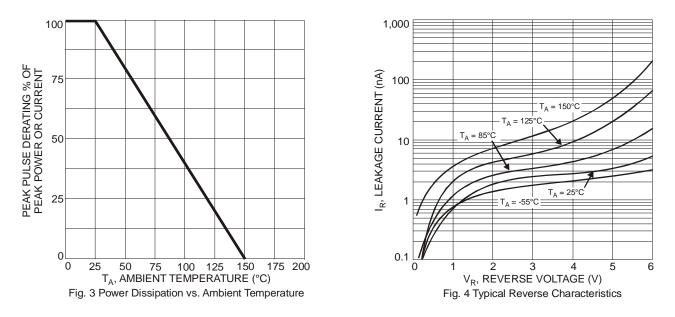
6. Short duration pulse test used to minimize self-heating effect.



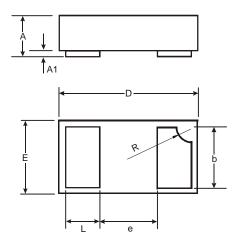




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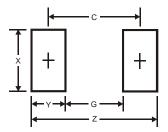


## **Package Outline Dimensions**



X2-DFN1006-2						
Dim	Min	Max	Тур			
Α	0.34	0.4	0.37			
A1	0	0.05	0.03			
b	0.45	0.55	0.50			
D	0.95	1.075	1.00			
Е	0.55	0.675	0.60			
Е			0.40			
L	0.20	0.30	0.25			
R	0.05	0.15	0.10			
All	All Dimensions in mm					

### **Suggested Pad Layout**



Dimensions	Value (in mm)
Z	1.1
G	0.3
Х	0.7
Y	0.4
С	0.7

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